

## N-Channel Super Junction Power MOSFET IV

### General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

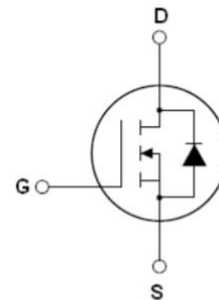
### Features

- Optimized body diode reverse recovery performance
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

|                        |      |            |
|------------------------|------|------------|
| $V_{DS\ min@T_{jmax}}$ | 550  | V          |
| $R_{DS(ON)TYP.}$       | 110  | m $\Omega$ |
| $I_D$                  | 23.5 | A          |
| $Q_g$                  | 24.5 | nC         |



Schematic diagram

✧ Intrinsic fast-recovery body diode

### Package Marking And Ordering Information

| Device      | Device Package | Marking     |
|-------------|----------------|-------------|
| NCE50NF130K | TO-252         | NCE50NF130K |



TO-252

Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$ )

| Parameter   | Symbol          | Value      | Unit                |
|---|-----------------|------------|---------------------|
| Drain-Source Voltage ( $V_{GS}=0V$ )                                | $V_{DS}$        | 500        | V                   |
| Gate-Source Voltage ( $V_{DS}=0V$ ), AC ( $f>1\text{ Hz}$ )         | $V_{GS}$        | $\pm 30$   | V                   |
| Gate-Source Voltage ( $V_{DS}=0V$ ), DC                             | $V_{GS}$        | $\pm 20$   | V                   |
| Continuous Drain Current at $T_c=25^\circ\text{C}$                  | $I_{D(DC)}$     | 23.5       | A                   |
| Continuous Drain Current at $T_c=100^\circ\text{C}$                 | $I_{D(DC)}$     | 16.45      | A                   |
| Pulsed drain current (Note 1)                                       | $I_{DM(pluse)}$ | 70.5       | A                   |
| Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )                 | $P_D$           | 186        | W                   |
| Derate above $25^\circ\text{C}$                                     |                 | 1.24       | W/ $^\circ\text{C}$ |
| Single pulse avalanche current (Note 2)                             | $I_{AS}$        | 6          | A                   |
| Reverse diode $dv/dt$ , $V_{DS} \leq 400\text{ V}$ , $I_{SD} < I_D$ | $dv/dt$         | 15         | V/ns                |
| Drain Source voltage slope, $V_{DS} \leq 400\text{ V}$              | $dv/dt$         | 50         | V/ns                |
| Operating Junction and Storage Temperature Range                    | $T_J, T_{STG}$  | -55...+175 | $^\circ\text{C}$    |

**Table 2. Thermal Characteristic**

| Parameter   | Symbol     | Value | Unit                        |
|---|------------|-------|-----------------------------|
| Thermal Resistance, Junction-to-Case (Maximum)    | $R_{thJC}$ | 0.80  | $^{\circ}\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Ambient (Maximum) | $R_{thJA}$ | 62    | $^{\circ}\text{C}/\text{W}$ |

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

| Parameter                                | Symbol              | Condition   | Min | Typ  | Max  | Unit |
|--|---------------------|---|-----|------|------|------|
| On/off states                            |                     |   |     |      |      |      |
| Drain-Source Breakdown Voltage           | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250uA   | 500 |      |      | V    |
| Zero Gate Voltage Drain Current(Tc=25℃)  | I <sub>DSS</sub>    | V <sub>DS</sub> =500V,V <sub>GS</sub> =0V   |     |      | 10   | μA   |
| Zero Gate Voltage Drain Current(Tc=125℃) | I <sub>DSS</sub>    | V <sub>DS</sub> =500V,V <sub>GS</sub> =0V   |     |      | 300  | μA   |
| Gate-Body Leakage Current                | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V   |     |      | ±200 | nA   |
| Gate Threshold Voltage                   | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250uA                               | 3   |      | 5    | V    |
| Drain-Source On-State Resistance         | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =12A   |     | 110  | 130  | mΩ   |
| Dynamic Characteristics                  |                     |   |     |      |      |      |
| Gate Resistance                          | R <sub>g</sub>      | F=1MHZ, D-S short   |     | 2    |      | Ω    |
| Input Capacitance                        | C <sub>iss</sub>    | V <sub>DS</sub> =50V,V <sub>GS</sub> =0V,<br>F=1MHz                                   |     | 1544 |      | pF   |
| Output Capacitance                       | C <sub>oss</sub>    |   |     | 630  |      | pF   |
| Reverse Transfer Capacitance             | C <sub>rss</sub>    |   |     | 6.1  |      | pF   |
| Total Gate Charge                        | Q <sub>g</sub>      | V <sub>DS</sub> =400V,I <sub>D</sub> =12A,<br>V <sub>GS</sub> =10V                    |     | 24.5 |      | nC   |
| Gate-Source Charge                       | Q <sub>gs</sub>     |   |     | 11.5 |      | nC   |
| Gate-Drain Charge                        | Q <sub>gd</sub>     |   |     | 6.5  |      | nC   |
| Gate plateau voltage                     | V <sub>gp</sub>     |   |     | 7.7  |      | V    |
| Switching times                          |                     |   |     |      |      |      |
| Turn-on Delay Time                       | t <sub>d(on)</sub>  | V <sub>DD</sub> =400V,I <sub>D</sub> =12A,<br>R <sub>G</sub> =4Ω,V <sub>GS</sub> =10V |     | 13   |      | nS   |
| Turn-on Rise Time                        | t <sub>r</sub>      |   |     | 10   |      | nS   |
| Turn-Off Delay Time                      | t <sub>d(off)</sub> |   |     | 58   |      | nS   |
| Turn-Off Fall Time                       | t <sub>f</sub>      |   |     | 9    |      | nS   |
| Source- Drain Diode Characteristics      |                     |   |     |      |      |      |
| Source-drain current(Body Diode)         | I <sub>SD</sub>     | T <sub>C</sub> =25℃   |     |      | 23.5 | A    |
| Pulsed-Source-drain current(Body Diode)  | I <sub>SDM</sub>    |   |     |      | 70.5 | A    |
| Forward on voltage                       | V <sub>SD</sub>     | T <sub>J</sub> =25℃,I <sub>SD</sub> =23.5A,V <sub>GS</sub> =0V                        |     | 0.9  | 1.1  | V    |
| Reverse Recovery Time                    | t <sub>rr</sub>     | T <sub>J</sub> =25℃,I <sub>F</sub> 12A,<br>di/dt=100A/μs                              |     | 170  |      | nS   |
| Reverse Recovery Charge                  | Q <sub>rr</sub>     |   |     | 1.02 |      | uC   |
| Peak reverse recovery current            | I <sub>rrm</sub>    |   |     | 12   |      | A    |

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2.  $T_j=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, R_G=25\Omega$

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

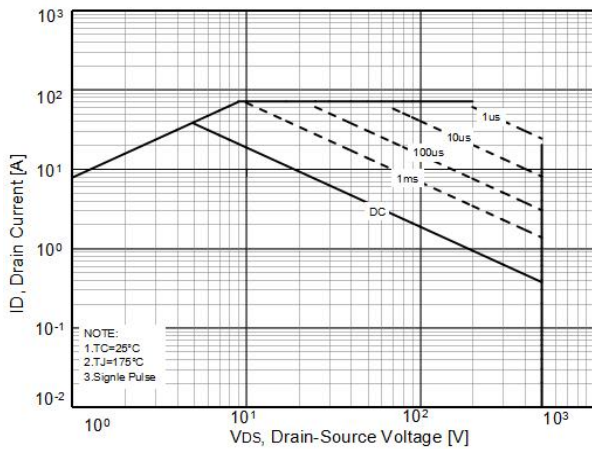


Figure2. Source-Drain Diode Forward Voltage

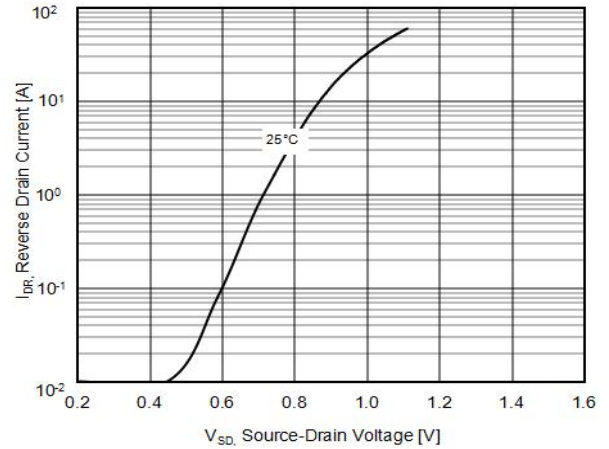


Figure3. Output characteristics

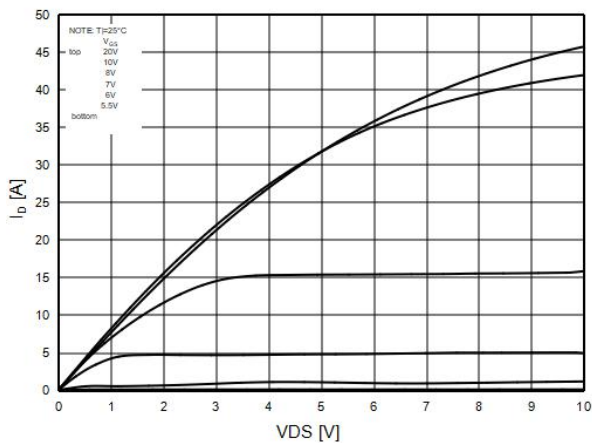


Figure4. Transfer characteristics

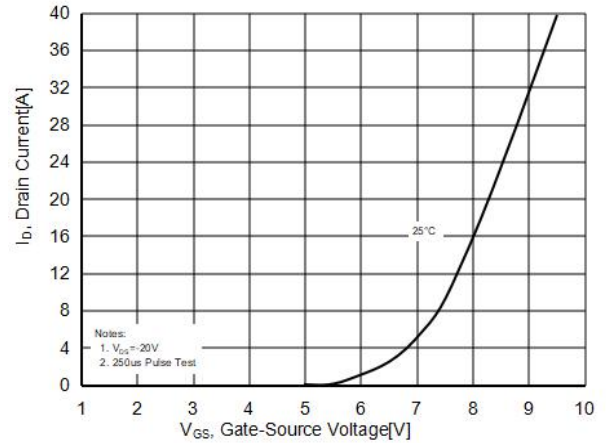


Figure5. Static drain-source on resistance

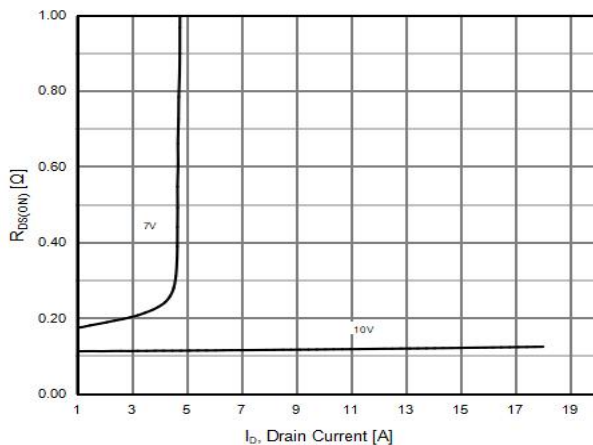
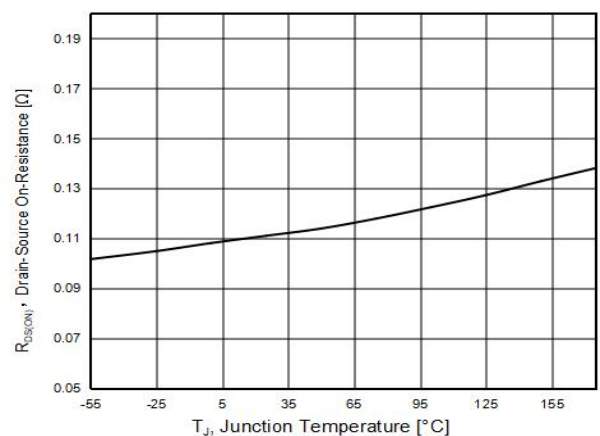
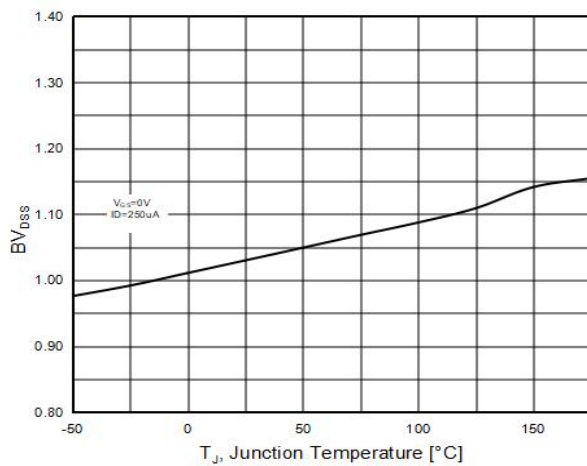


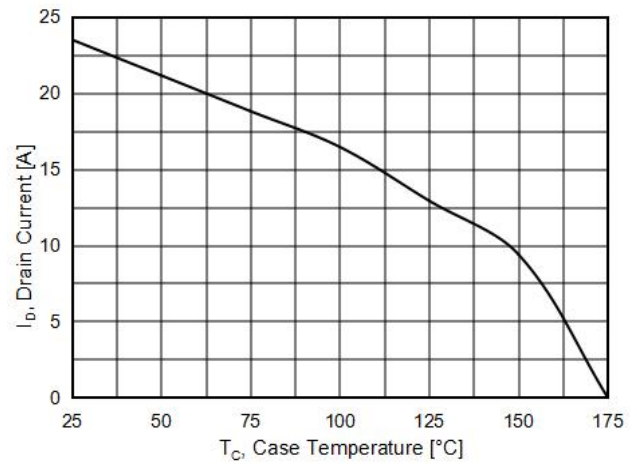
Figure6.  $R_{DS(on)}$  vs Junction Temperature



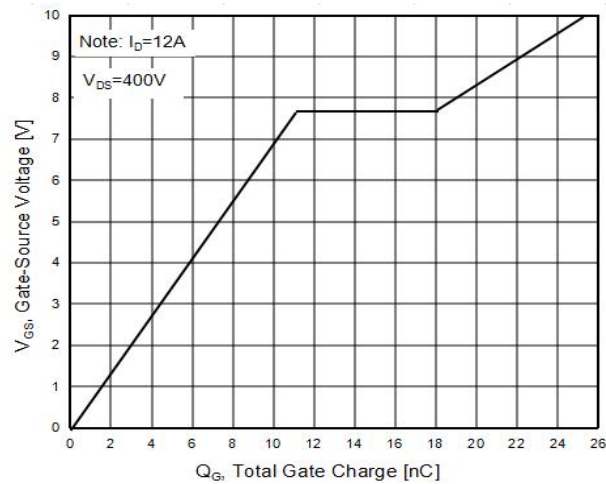
**Figure7.  $BV_{DSS}$  vs Junction Temperature**



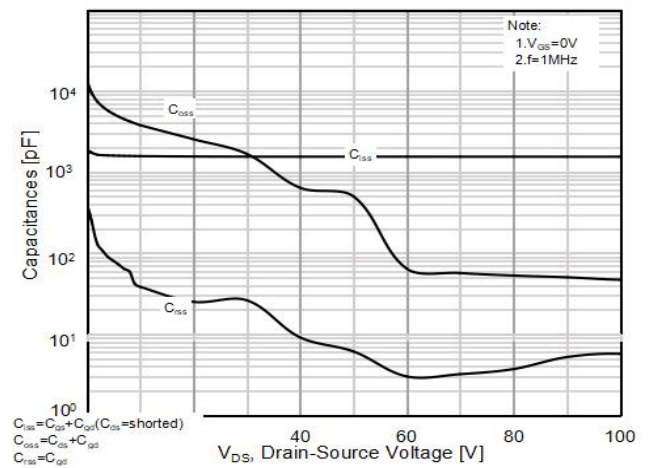
**Figure8. Maximum  $I_D$  vs Junction Temperature**



**Figure9. Gate charge waveforms**



**Figure10. Capacitance**



## Test circuit

### 1) Gate charge test circuit & Waveform



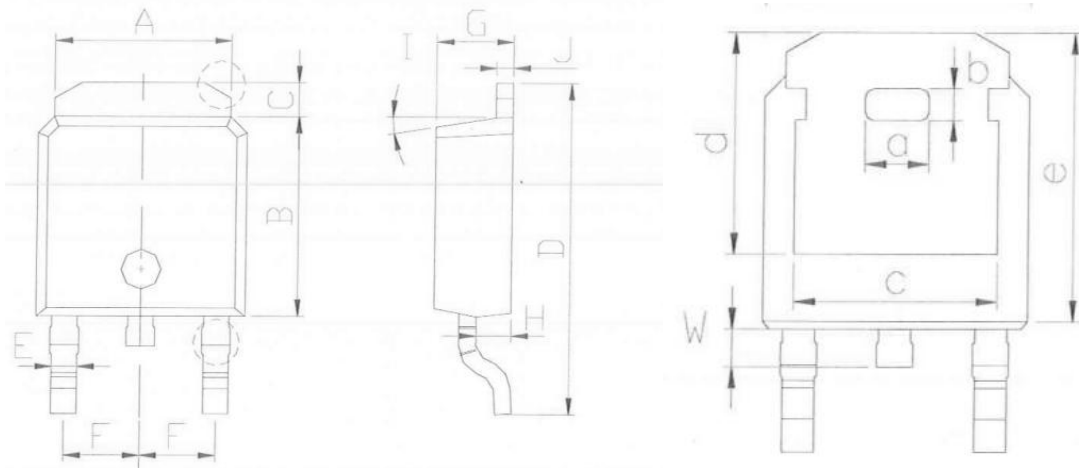
### 2) Switch Time Test Circuit:



### 3) Unclamped Inductive Switching Test Circuit & Waveforms



## TO-252 Package Information



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 5.04                      | 5.64  | 0.198                | 0.222 |
| B      | 5.70                      | 6.03  | 0.224                | 0.237 |
| C      | 0.75                      | 1.35  | 0.030                | 0.053 |
| D      | 9.65                      | 10.25 | 0.380                | 0.404 |
| E      | 0.61                      | 0.91  | 0.024                | 0.036 |
| F      | 2.13                      | 2.43  | 0.084                | 0.096 |
| G      | 2.00                      | 2.60  | 0.079                | 0.102 |
| H      | 0.76                      | 1.36  | 0.030                | 0.054 |
| J      | 0.36                      | 0.66  | 0.014                | 0.026 |
| W      | 0.60                      | 1.20  | 0.024                | 0.047 |
| a      | 1.50                      | 2.10  | 0.059                | 0.083 |
| b      | 0.45                      | 1.05  | 0.018                | 0.041 |
| c      | 4.55                      | 5.15  | 0.179                | 0.203 |
| d      | 5.00                      | 5.60  | 0.197                | 0.220 |
| e      | 6.60                      | 7.20  | 0.260                | 0.283 |

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